

Freeform Search

Database: US Pre-Grant Publication Full-Text Database
US Patents Full-Text Database
US OCR Full-Text Database
EPO Abstracts Database
JPO Abstracts Database
Derwent World Patents Index
IBM Technical Disclosure Bulletins

Term: L39 and L1

Display: **Documents in Display Format:** **Starting with Number**

Generate: ☐ Hit List ☒ Hit Count ☐ Side by Side ☐ Image

Search

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Search History

DATE: Wednesday, December 19, 2007 [Purge Queries](#) [Printable Copy](#) [Create Case](#)



<u>Set</u> <u>Name</u> side by side	<u>Query</u>	<u>Hit</u> <u>Count</u>	<u>Set</u> <u>Name</u> result set
	DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
L40	L39 and L1	44	L40
L39	polyimide film	28459	L39
	DB=USPT; PLUR=YES; OP=ADJ		
L38	polyimide passivat\$3	214	L38
	DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ		
L37	338/\$.ccls. and L34	0	L37
L36	L34 and L4	0	L36
L35	L34 and L1	0	L35
L34	polyimide passivat\$3	389	L34
L33	L31 and L4	0	L33
L32	L31 and L1	0	L32
L31	polyimide resist	527	L31
	DB=USPT; PLUR=YES; OP=ADJ		
L30	6762671.pn. and (flexible or polyimide or stainless)	0	L30
L29	6354736.pn. and (polyimide)	0	L29

<u>L28</u>	6077228.pn. and (resist or passivation)	0	<u>L28</u>
<u>L27</u>	L26 and (resist or passivation)	0	<u>L27</u>
<u>L26</u>	5558099.pn.	1	<u>L26</u>
<u>L25</u>	L23 and (resist\$3 or wiring or film or foil)	161	<u>L25</u>
<u>L24</u>	L23 and L1	0	<u>L24</u>
<u>L23</u>	polyimide passivation	185	<u>L23</u>
<u>L22</u>	L20 and (polyimide)	0	<u>L22</u>
<u>L21</u>	L20 and (flexible)	0	<u>L21</u>
<u>L20</u>	5430428.pn.	1	<u>L20</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>			
<u>L19</u>	flexible polyimide ceramic	2	<u>L19</u>
<u>L18</u>	flexible ceramic substrate same polyimide	2	<u>L18</u>
<u>L17</u>	flexible ceramic substrate	35	<u>L17</u>
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L16</u>	L15 and (substrate)	1	<u>L16</u>
<u>L15</u>	6341892.pn.	1	<u>L15</u>
<i>DB=PGPB; PLUR=YES; OP=ADJ</i>			
<u>L14</u>	L13 and (flat)	0	<u>L14</u>
<u>L13</u>	20020071475	1	<u>L13</u>
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L12</u>	L10 and (temperature or thermistor)	16	<u>L12</u>
<u>L11</u>	338/\$.ccls. and (Lovell) and (temperature sens\$3 or thermal\$2 sens\$3)	0	<u>L11</u>
<u>L10</u>	338/\$.ccls. and (Lovell)	20	<u>L10</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>			
<u>L9</u>	L8 and (flexible)	129	<u>L9</u>
<u>L8</u>	374/185	714	<u>L8</u>
<u>L7</u>	(meander or serpentine) same (flex circuit or flexible substrate or flexible near circuit) and (temperature or thermal)	105	<u>L7</u>
<u>L6</u>	(meander or serpentine) same (flex circuit or flexible substrate or flexible near circuit)	175	<u>L6</u>
<u>L5</u>	L4 and (flex circuit or flexible substrate or flexible near circuit)	10	<u>L5</u>
<u>L4</u>	338/\$.ccls. and (serpentine or meander) same (substrate)	187	<u>L4</u>
<u>L3</u>	L1 and (serpentine or meander) same (substrate)	31	<u>L3</u>
<u>L2</u>	L1 and (metal foil near resist\$4)	4	<u>L2</u>
<u>L1</u>	374/\$.ccls.	29910	<u>L1</u>

END OF SEARCH HISTORY

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Term:	L26 and (electrostatic)	 
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Display:	<input type="text" value="10"/>	Documents in Display Format:	<input type="text" value="Tl"/>	Starting with Number	<input type="text" value="1"/>
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<u>Set Name</u>	<u>Query</u>	<u>Hit Count</u>	<u>Set Name</u> result set
side by side			
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L27</u>	L26 and (electrostatic)	1	<u>L27</u>
<u>L26</u>	6353210.pn.	1	<u>L26</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>			
<u>L25</u>	L23 and (shap\$3 near substrate)	172	<u>L25</u>
<u>L24</u>	L23 and (narrow near substrate)	12	<u>L24</u>
<u>L23</u>	338/\$.ccls.	38672	<u>L23</u>
<i>DB=PGPB; PLUR=YES; OP=ADJ</i>			
<u>L22</u>	10694772	0	<u>L22</u>
<i>DB=PGPB,USPT,USOC,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=ADJ</i>			
<u>L21</u>	L4 and (flat) and (narrow) and (base insulat\$3) and (conductor layer)	0	<u>L21</u>
<u>L20</u>	L4 and (substrate) and (thermal resist\$4 or thermistor or RTD)	529	<u>L20</u>
<u>L19</u>	6479801.pn.	3	<u>L19</u>
<u>L18</u>	6616332.pn.	2	<u>L18</u>
<u>L17</u>	L4 and (substrate) and (temperature sensor)	843	<u>L17</u>
<u>L16</u>	L14 and L4	18	<u>L16</u>

<u>L15</u>	L14 and L10	0	<u>L15</u>
<u>L14</u>	substrate near shape	15505	<u>L14</u>
<u>L13</u>	L10 and (insulat\$4 near substrate)	4	<u>L13</u>
<u>L12</u>	L5 and (insulat\$4 near substrate)	4	<u>L12</u>
<u>L11</u>	L5 and (stainless near conductor)	0	<u>L11</u>
<u>L10</u>	L8 and (temperature near resist\$4 or thermal\$2 near resist\$4 or RTD or thermistor\$1)	264	<u>L10</u>
<u>L9</u>	L8 and (resist\$4)	410	<u>L9</u>
<u>L8</u>	L7 and (temperature or thermal\$2)	689	<u>L8</u>
<u>L7</u>	L6 and L4	718	<u>L7</u>
<u>L6</u>	702/\$.ccls.	47023	<u>L6</u>
<u>L5</u>	L4 and L3	58	<u>L5</u>
<u>L4</u>	374/\$.ccls.	29910	<u>L4</u>
<u>L3</u>	flexible circuit board or flexible PCB or flexible integrated circuit or flexible substrate	39512	<u>L3</u>
<i>DB=USPT; PLUR=YES; OP=ADJ</i>			
<u>L2</u>	5053740.pn.	1	<u>L2</u>
<u>L1</u>	6341892.pn.	1	<u>L1</u>

END OF SEARCH HISTORY